NX3L2T66 Dual low-ohmic single-pole single-throw analog switch Rev. 7 – 8 February 2013 Product data sheet

1. General description

The NX3L2T66 is a dual low-ohmic single-pole single-throw analog switch. Each switch has two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When pin nE is LOW, the analog switch is turned off.

Schmitt trigger action at the enable input (nE) makes the circuit tolerant to slower input rise and fall times. A low input voltage threshold allows pin nE to be driven by lower level logic signals without a significant increase in supply current I_{CC} . This makes it possible for the NX3L2T66 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation.

The NX3L2T66 allows signals with amplitude up to V_{CC} to be transmitted from nY to nZ; or from nZ to nY. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.6 Ω (typical) at V_{CC} = 1.4 V
 - 1.0 Ω (typical) at V_{CC} = 1.65 V
 - 0.55 Ω (typical) at V_{CC} = 2.3 V
 - 0.50 Ω (typical) at V_{CC} = 2.7 V
 - 0.50 Ω (typical) at V_{CC} = 4.3 V
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - IEC61000-4-2 contact discharge exceeds 4000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- 1.8 V control logic at V_{CC} = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



Dual low-ohmic single-pole single-throw analog switch

3. Applications

- Cell phone
- PDA
- Portable media player

4. Ordering information

Table 1. Ordering information

| Type number | Package | Package | | | | | | | |
|-------------|-------------------|---------|---|----------|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | |
| NX3L2T66GT | –40 °C to +125 °C | XSON8 | plastic extremely thin small outline package; no leads; 8 terminals; body 1 \times 1.95 \times 0.5 mm | SOT833-1 | | | | | |
| NX3L2T66GD | –40 °C to +125 °C | XSON8 | plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm | SOT996-2 | | | | | |
| NX3L2T66GM | –40 °C to +125 °C | XQFN8 | plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6 \times 1.6 \times 0.5$ mm | SOT902-2 | | | | | |

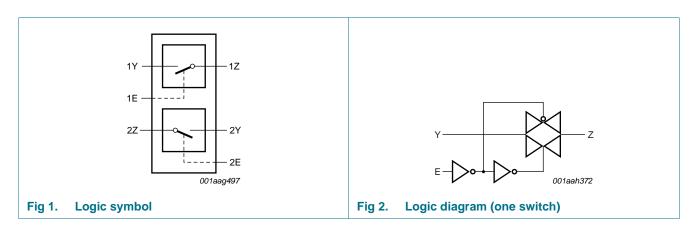
5. Marking

Table 2. Marking codes^[1]

| Type number | Marking code |
|-------------|--------------|
| NX3L2T66GT | DOO |
| NX3L2T66GD | DOO |
| NX3L2T66GM | DOO |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram

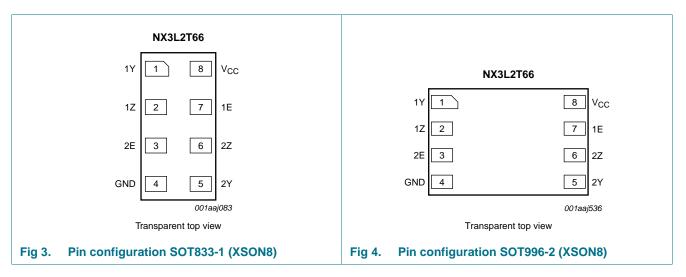


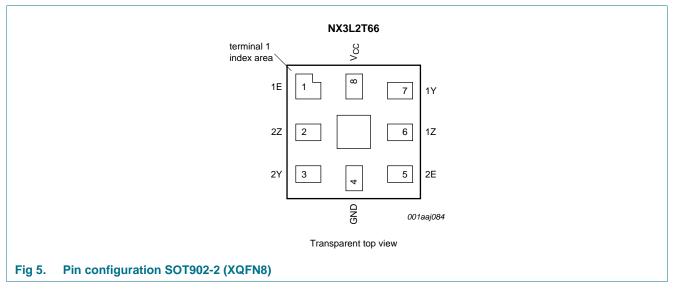
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7. Pinning information

7.1 Pinning





7.2 Pin description

| Symbol | Pin | | Description |
|-----------------|-----------------------|----------|-----------------------------|
| - | SOT833-1 and SOT996-2 | SOT902-2 | |
| 1Y, 2Y | 1, 5 | 7, 3 | independent input or output |
| 1Z, 2Z | 2, 6 | 6, 2 | independent input or output |
| GND | 4 | 4 | ground (0 V) |
| 1E, 2E | 7, 3 | 1, 5 | enable input (active HIGH) |
| V _{CC} | 8 | 8 | supply voltage |

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8. Functional description

Table 4.Function table^[1]

| Input nE | Switch |
|----------|-----------|
| L | OFF-state |
| Н | ON-state |

[1] H = HIGH voltage level;

L = LOW voltage level.

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|-----------------|-----------------------|------|
| V _{CC} | supply voltage | | -0.5 | +4.6 | V |
| VI | input voltage | enable input nE | <u>[1]</u> –0.5 | +4.6 | V |
| V _{SW} | switch voltage | | <u>[2]</u> –0.5 | V _{CC} + 0.5 | V |
| I _{IK} | input clamping current | $V_{I} < -0.5 V$ | -50 | - | mA |
| I _{SK} | switch clamping current | $V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V | - | ±50 | mA |
| I _{SW} | switch current | V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current | - | ±350 | mA |
| | | V _{SW} > –0.5 V or V _{SW} < V _{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current | - | ±500 | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \text{ °C to } +125 \text{ °C}$ | <u>[3]</u> _ | 250 | mW |

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For XSON8 and XQFN8 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

10. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|-------------------------------------|---------------------------|--------------|-----|-----------------|------|
| V _{CC} | supply voltage | | 1.4 | - | 4.3 | V |
| VI | input voltage | enable input nE | 0 | - | 4.3 | V |
| V _{SW} | switch voltage | | <u>[1]</u> 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall rate | V_{CC} = 1.4 V to 4.3 V | [2] _ | - | 200 | ns/V |

[1] To avoid sinking GND current from terminal nZ when switch current flows in terminal nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nY. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

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11. Static characteristics

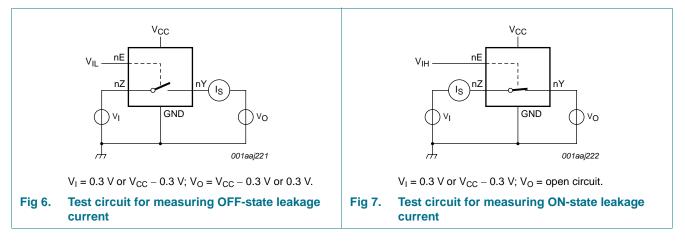
Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol | Parameter | Conditions | Ta | amb = 25 | °C | T _{amb} = - | –40 °C to | +125 °C | Unit |
|----------------------------|--------------------------|--|-----|----------|------|----------------------|----------------|-----------------|------|
| | | | Min | Тур | Max | Min | Max (85 °C) | Max (125 °C) | |
| V _{IH} | HIGH-level | $V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$ | 0.9 | - | - | 0.9 | - | - | V |
| | input voltage | $V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$ | 0.9 | - | - | 0.9 | - | - | V |
| | | V_{CC} = 2.3 V to 2.7 V | 1.1 | - | - | 1.1 | - | - | V |
| | | V_{CC} = 2.7 V to 3.6 V | 1.3 | - | - | 1.3 | - | - | V |
| | | V_{CC} = 3.6 V to 4.3 V | 1.4 | - | - | 1.4 | - | - | V |
| V _{IL} | LOW-level | $V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$ | - | - | 0.3 | - | 0.3 | 0.3 | V |
| | input voltage | V_{CC} = 1.65 V to 1.95 V | - | - | 0.4 | - | 0.4 | 0.3 | V |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.4 | - | 0.4 | 0.4 | V |
| | | V_{CC} = 2.7 V to 3.6 V | - | - | 0.5 | - | 0.5 | 0.5 | V |
| | | V_{CC} = 3.6 V to 4.3 V | - | - | 0.6 | - | 0.6 | 0.6 | V |
| I | input leakage current | enable input nE; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V | - | - | - | - | ±0.5 | ±1 | μA |
| I _{S(OFF)} | OFF-state | nY port; see <u>Figure 6</u> | | | | | | | |
| | leakage | $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$ | - | - | ±5 | - | ±50 | ±500 | nA |
| | current | $V_{CC} = 3.6 V \text{ to } 4.3 V$ | - | - | ±10 | - | ±50 | ±500 | nA |
| I _{S(ON)} | ON-state | nZ port; see <u>Figure 7</u> | | | | | | | |
| | leakage | $V_{CC} = 1.4 \text{ V} \text{ to } 3.6 \text{ V}$ | - | - | ±5 | - | ±50 | ±500 | nA |
| | current | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$ | - | - | ±10 | - | ±50 | ±500 | nA |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC} | | | | | | | |
| | | $V_{CC} = 3.6 V$ | - | - | 100 | - | 690 | 6000 | nA |
| | | $V_{CC} = 4.3 V$ | - | - | 150 | - | 800 | 7000 | nA |
| ΔI_{CC} | additional | V_{SW} = GND or V_{CC} | | | | | | | |
| | supply current | $V_1 = 2.6 V; V_{CC} = 4.3 V$ | - | 2.0 | 4.0 | - | 7 | 7 | μA |
| | | $V_1 = 2.6 V; V_{CC} = 3.6 V$ | - | 0.35 | 0.7 | - | 1 | 1 | μA |
| | | $V_{I} = 1.8 V; V_{CC} = 4.3 V$ | - | 7.0 | 10.0 | - | 15 | 15 | μA |
| | | $V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$ | - | 2.5 | 4.0 | - | 5 | 5 | μA |
| | | $V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$ | - | 50 | 200 | - | 300 | 500 | nA |
| CI | input capacitance | | - | 1.0 | - | - | - | - | pF |
| $C_{\text{S}(\text{OFF})}$ | OFF-state capacitance | | - | 35 | - | - | - | - | pF |
| C _{S(ON)} | ON-state capacitance | | - | 110 | - | - | - | - | pF |

Dual low-ohmic single-pole single-throw analog switch

11.1 Test circuits



11.2 ON resistance

Table 8.ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 9 to Figure 15.

| Symbol | Parameter | ParameterConditions $T_{amb} = -40$ °C to +85 °C | | | -40 °C to 5 °C | Unit | | |
|-----------------------|---|--|-----|----------------------|-------------------|------|-----|---|
| | | | Min | Typ <mark>[1]</mark> | Max | Min | Max | |
| R _{ON(peak)} | ON resistance (peak) | $V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA};$ see <u>Figure 8</u> | | | | | | |
| | | $V_{CC} = 1.4 V$ | - | 1.6 | 3.7 | - | 4.1 | Ω |
| | | V _{CC} = 1.65 V | - | 1.0 | 1.6 | - | 1.7 | Ω |
| | | $V_{CC} = 2.3 V$ | - | 0.55 | 0.8 | - | 0.9 | Ω |
| | | $V_{CC} = 2.7 V$ | - | 0.5 | 0.75 | - | 0.9 | Ω |
| | | $V_{CC} = 4.3 V$ | - | 0.5 | 0.75 | - | 0.9 | Ω |
| ΔR_{ON} | ON resistance mismatch between channels | $V_I = GND$ to V_{CC} ; $I_{SW} = 100 \text{ mA}$ | [2] | | | | | |
| | | $V_{CC} = 1.4 V$ | - | 0.04 | 0.3 | - | 0.3 | Ω |
| | | V _{CC} = 1.65 V | - | 0.04 | 0.2 | - | 0.3 | Ω |
| | | $V_{CC} = 2.3 V$ | - | 0.02 | 0.08 | - | 0.1 | Ω |
| | | $V_{CC} = 2.7 V$ | - | 0.02 | 0.075 | - | 0.1 | Ω |
| | | $V_{CC} = 4.3 V$ | - | 0.02 | 0.075 | - | 0.1 | Ω |

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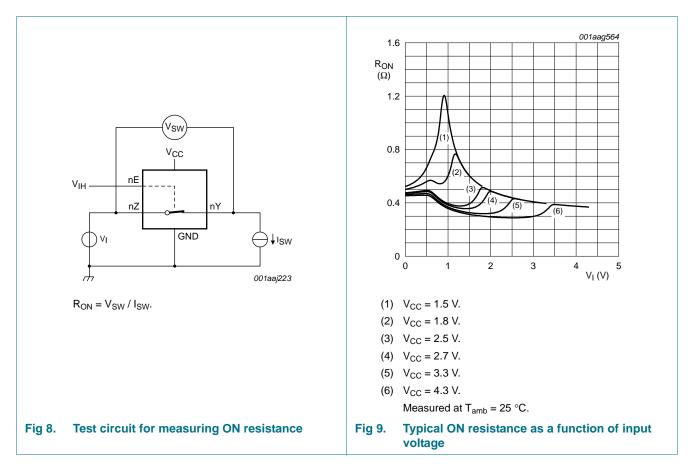
| Symbol | Parameter | Conditions T _a | | T _{amb} = -40 °C to +85 °C | | | T _{amb} = −40 °C to +125 °C | | |
|-------------------------------------|--------------------------|--|-----|--|-----|-----|---|---|--|
| | | | Min | Typ[1] | Max | Min | Max | | |
| R _{ON(flat)} ON resistance | ON resistance (flatness) | $V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$ | | | ' | | | | |
| | | $V_{CC} = 1.4 V$ | - | 1.0 | 3.3 | - | 3.6 | Ω | |
| | | V _{CC} = 1.65 V | - | 0.5 | 1.2 | - | 1.3 | Ω | |
| | | $V_{CC} = 2.3 V$ | - | 0.15 | 0.3 | - | 0.35 | Ω | |
| | | $V_{CC} = 2.7 V$ | - | 0.13 | 0.3 | - | 0.35 | Ω | |
| | | $V_{CC} = 4.3 V$ | - | 0.2 | 0.4 | - | 0.45 | Ω | |

Table 8. **ON resistance** ... continued

[1] Typical values are measured at T_{amb} = 25 °C.

Measured at identical $V_{\mbox{CC}},$ temperature and input voltage. [2]

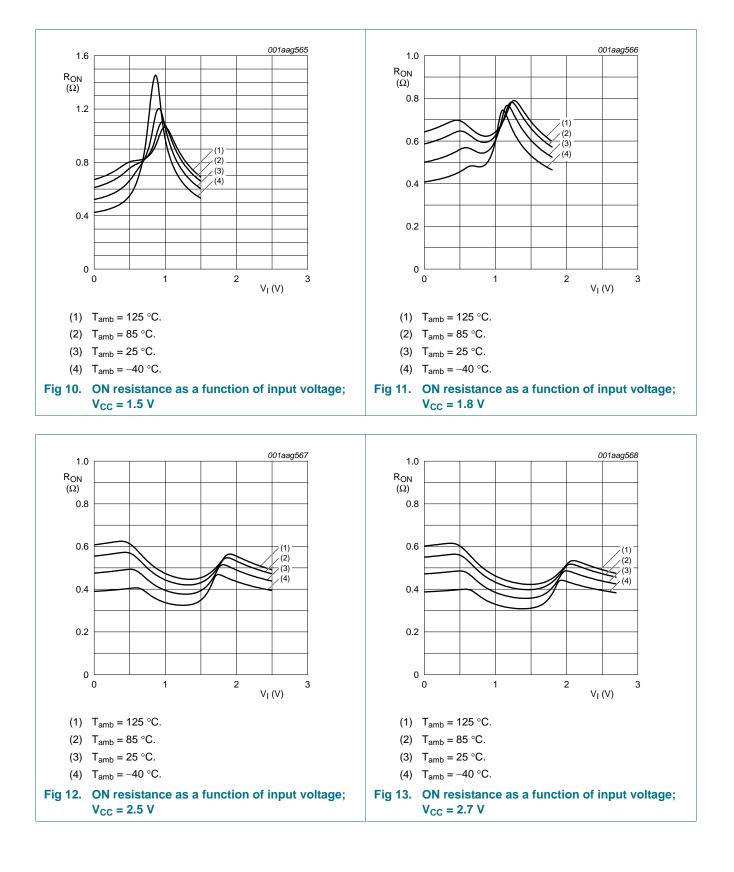
Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and [3] temperature.



11.3 ON resistance test circuit and graphs

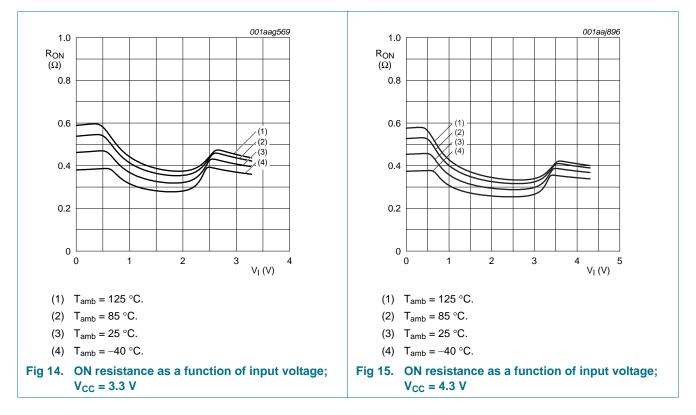
NX3L2T66

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12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

| Symbol | Symbol Parameter Conditions | | Ta | _{mb} = 25 | °C | T _{amb} = | –40 °C to | +125 °C | Unit |
|------------------|-----------------------------|--|-----|---------------------------|-----|--------------------|----------------|-----------------|------|
| | | | Min | Тур <u>^[1]</u> | Мах | Min | Max (85 °C) | Max (125 °C) | |
| t _{en} | enable time | nE to nZ or nY; see <u>Figure 16</u> | | | | | | | |
| | | $V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$ | - | 35 | 49 | - | 53 | 57 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | - | 28 | 40 | - | 43 | 48 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | - | 20 | 30 | - | 32 | 35 | ns |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | - | 18 | 28 | - | 30 | 32 | ns |
| | | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$ | - | 18 | 28 | - | 30 | 32 | ns |
| t _{dis} | disable time | nE to nZ or nY; see <u>Figure 16</u> | | | | | | | |
| | | $V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$ | - | 32 | 70 | - | 80 | 90 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | - | 23 | 55 | - | 60 | 65 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | - | 14 | 25 | - | 30 | 35 | ns |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | - | 11 | 20 | - | 25 | 30 | ns |
| | | V_{CC} = 3.6 V to 4.3 V | - | 11 | 20 | - | 25 | 30 | ns |

[1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.5$ V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

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12.1 Waveform and test circuits

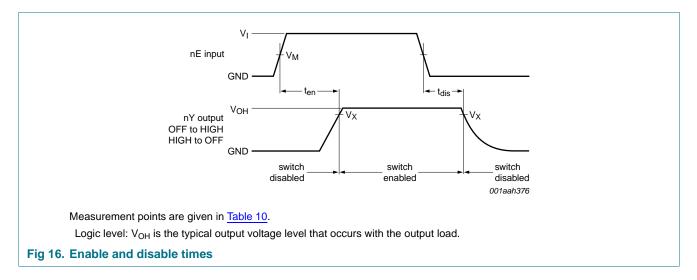


Table 10.Measurement points

| Supply voltage | Input | Output |
|-----------------|--------------------|--------------------|
| V _{CC} | V _M | V _X |
| 1.4 V to 4.3 V | 0.5V _{CC} | 0.9V _{OH} |

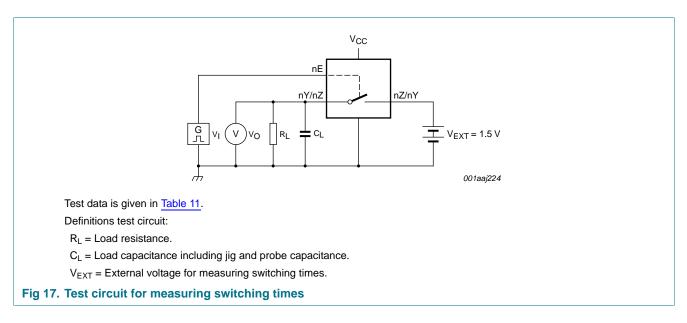


Table 11. Test data

| Supply voltage | Input | | Load | |
|-----------------|-----------------|---------------------------------|-------|------|
| V _{cc} | VI | t _r , t _f | CL | RL |
| 1.4 V to 4.3 V | V _{CC} | \leq 2.5 ns | 35 pF | 50 Ω |

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12.2 Additional dynamic characteristics

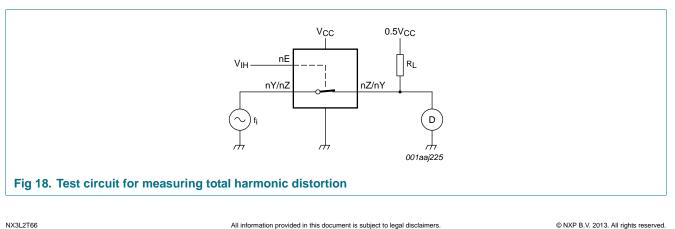
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_1 = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5 \text{ ns.}$

| Symbol | Parameter | Conditions | T _{amb} = 25 °C | | | Unit | |
|---------------------|------------------------------|---|--------------------------|-----|------|------|-----|
| | | | | Min | Тур | Max | |
| THD | total harmonic distortion | $f_i = 20$ Hz to 20 kHz; $R_L = 32 \Omega$; see Figure 18 | <u>[1]</u> | | 1 | | |
| | | V _{CC} = 1.4 V; V _I = 1 V (p-p) | | - | 0.15 | - | % |
| | | V _{CC} = 1.65 V; V _I = 1.2 V (p-p) | | - | 0.10 | - | % |
| | | V _{CC} = 2.3 V; V _I = 1.5 V (p-p) | | - | 0.02 | - | % |
| | | $V_{CC} = 2.7 \text{ V}; \text{ V}_{I} = 2 \text{ V} (p-p)$ | | - | 0.02 | - | % |
| | | $V_{CC} = 4.3 \text{ V}; \text{ V}_{I} = 2 \text{ V} (p-p)$ | | - | 0.02 | - | % |
| f _(-3dB) | –3 dB frequency response | $R_L = 50 \Omega$; see <u>Figure 19</u> | <u>[1]</u> | | | | |
| | | $V_{CC} = 1.4 \text{ V} \text{ to } 4.3 \text{ V}$ | | - | 60 | - | MHz |
| α_{iso} | isolation (OFF-state) | $f_i = 100 \text{ kHz}; \text{ R}_L = 50 \Omega; \text{ see } \frac{\text{Figure 20}}{1000 \text{ kHz}}$ | <u>[1]</u> | | | | |
| | | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$ | | - | -90 | - | dB |
| V _{ct} | crosstalk voltage | between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 21 | | | | | |
| | | $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$ | | - | 0.2 | - | V |
| | | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$ | | - | 0.2 | - | V |
| Xtalk | crosstalk | between switches; $f_i = 100 \text{ kHz; } R_L = 50 \Omega$; see <u>Figure 22</u> | <u>[1]</u> | | | | |
| | | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$ | | - | -90 | - | dB |
| Q _{inj} | charge injection | $f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure } 23}{2}$ | | | | | |
| | | V _{CC} = 1.5 V | | - | 3 | - | рС |
| | | V _{CC} = 1.8 V | | - | 3 | - | рС |
| | | $V_{CC} = 2.5 V$ | | - | 3 | - | рС |
| | | $V_{CC} = 3.3 V$ | | - | 3 | - | рС |
| | | $V_{CC} = 4.3 V$ | | - | 6 | - | рС |

[1] f_i is biased at 0.5V_{CC}.

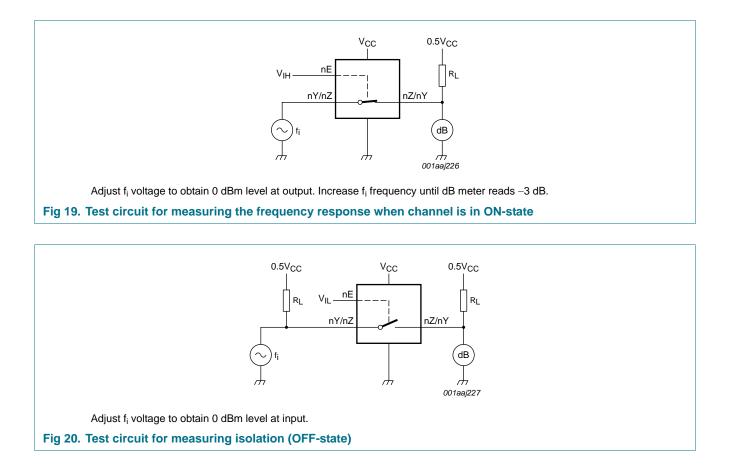
12.3 Test circuits



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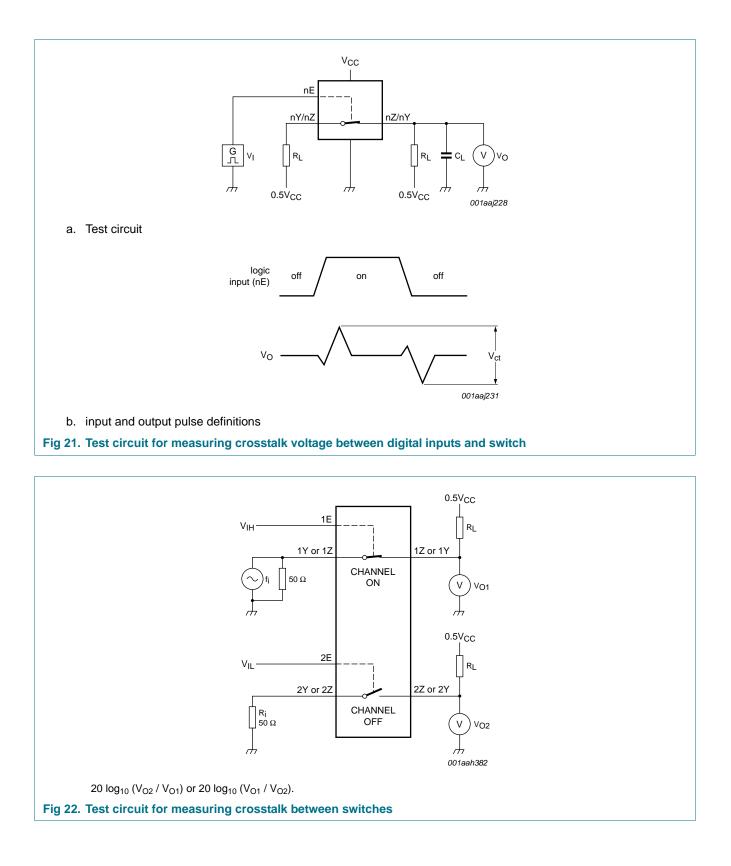
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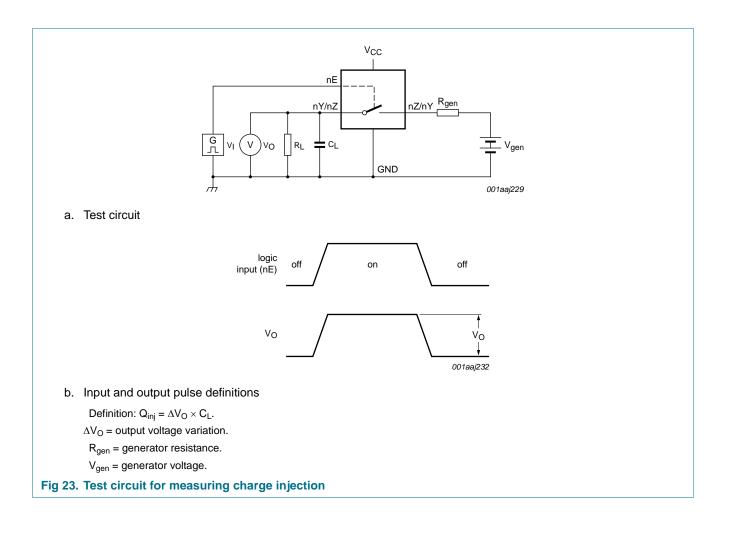
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Dual low-ohmic single-pole single-throw analog switch



NX3L2T66

Dual low-ohmic single-pole single-throw analog switch



Dual low-ohmic single-pole single-throw analog switch

13. Package outline

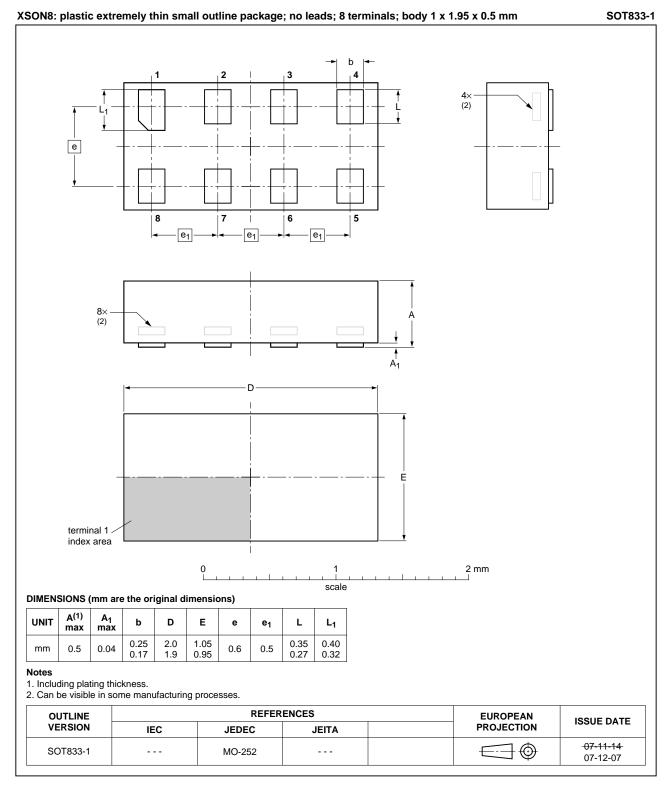
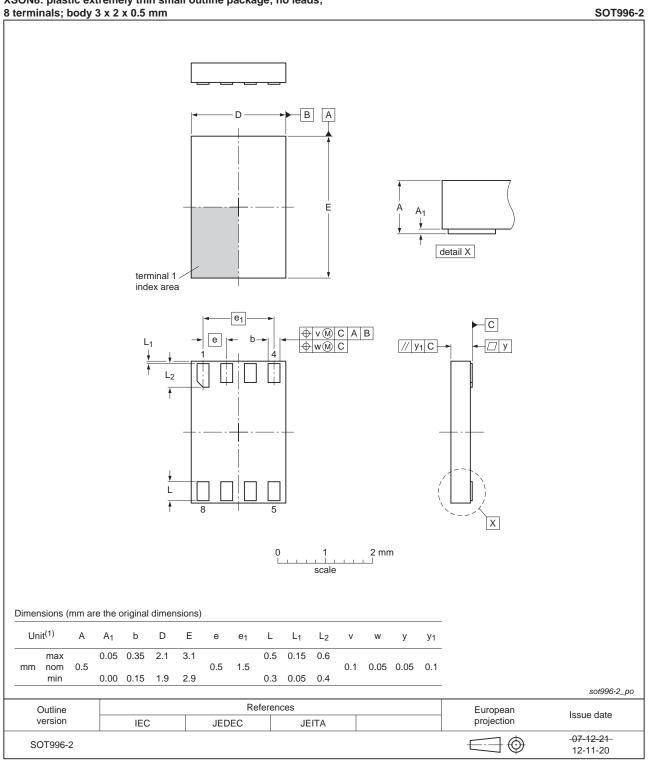


Fig 24. Package outline SOT833-1 (XSON8)

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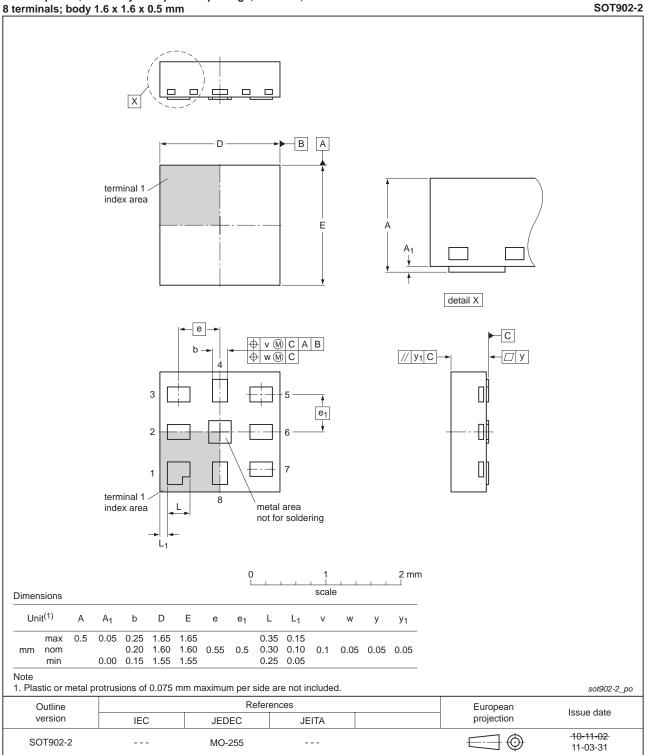


XSON8: plastic extremely thin small outline package; no leads;

Fig 25. Package outline SOT996-2 (XSON8)

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Dual low-ohmic single-pole single-throw analog switch



XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals: body 1.6 x 1.6 x 0.5 mm

Fig 26. Package outline SOT902-2 (XQFN8)

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14. Abbreviations

| AcronymDescriptionCDMCharged Device ModelCMOSComplementary Metal Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body ModelMMMachine ModelPDAPersonal Digital Assistant | Table 13. Abbreviations | | | |
|---|-------------------------|---|--|--|
| CMOSComplementary Metal Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body ModelMMMachine Model | Acronym | Description | | |
| ESDElectroStatic DischargeHBMHuman Body ModelMMMachine Model | CDM | Charged Device Model | | |
| HBM Human Body Model MM Machine Model | CMOS | Complementary Metal Oxide Semiconductor | | |
| MM Machine Model | ESD | ElectroStatic Discharge | | |
| | HBM | Human Body Model | | |
| PDA Personal Digital Assistant | MM | Machine Model | | |
| | PDA | Personal Digital Assistant | | |

15. Revision history

| Table 14. Revisior | n history | | | |
|--------------------|-----------------------------------|----------------------|-----------------------|--------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| NX3L2T66 v.7 | 20130208 | Product data sheet | - | NX3L2T66 v.6 |
| Modifications: | For type null | mber NX3L2T66GD XSON | 8U has changed to XSO | N8. |
| NX3L2T66 v.6 | 20120606 | Product data sheet | - | NX3L2T66 v.5 |
| NX3L2T66 v.5 | 20111107 | Product data sheet | - | NX3L2T66 v.4 |
| NX3L2T66 v.4 | 20101229 | Product data sheet | - | NX3L2T66 v.3 |
| NX3L2T66 v.3 | 20090828 | Product data sheet | - | NX3L2T66 v.2 |
| NX3L2T66 v.2 | 20090420 | Product data sheet | - | NX3L2T66 v.1 |
| NX3L2T66 v.1 | 20081204 | Product data sheet | - | - |
| | | | | |

16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Dual low-ohmic single-pole single-throw analog switch

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NX3L2T66

Dual low-ohmic single-pole single-throw analog switch

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